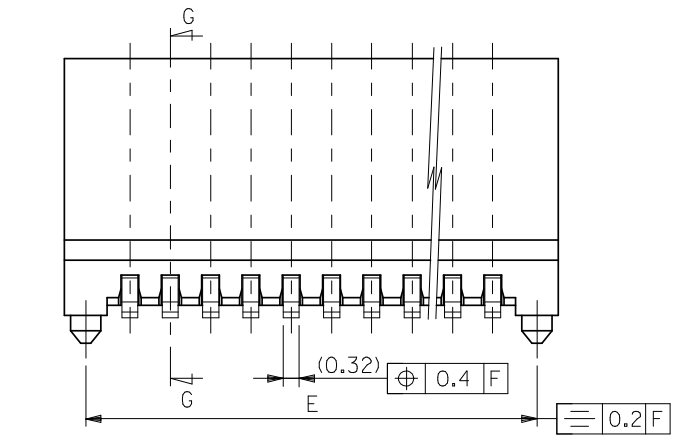
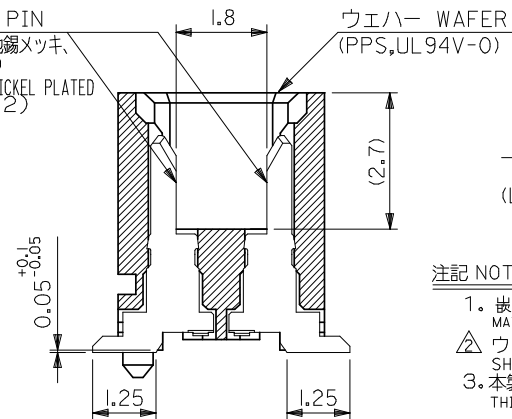
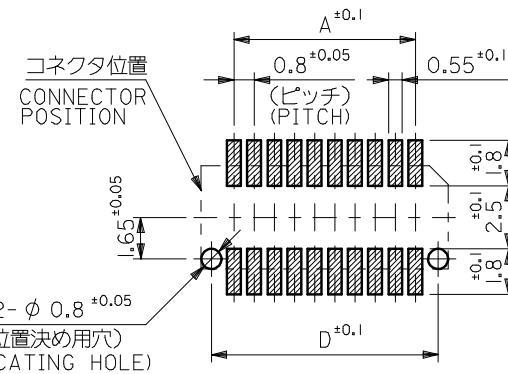
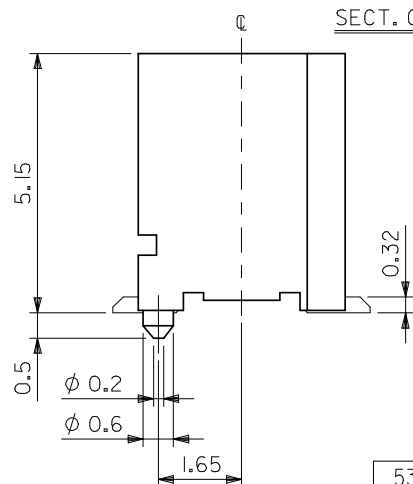




ピン PIN
(リン青銅、ニッケル下地錫メッキ、
t=0.32)
(PHOS-BRO. TIN OVER NICKEL PLAT
t=0.32)



SECT. G-G



参考基板レイアウト（マウント面）

P.C.B. PATTERN LAYOUT (REF.) (MOUNT AREA)

注記 NOTES

1. 炭合相手: 52465 シリーズ
MATES WITH: 52465 SERIES
- △ ウエハの ㊦ から隣接するピンの ㊦ 迄の位置を示す。
SHOW POSITION FROM ㊦ OF WAFER TO ㊦ OF ADJACENT PINS.
3. 本製品は 53364-***17 の鉛フリー品である。
THIS PRODUCT IS LEAD FREE OF 53364-***17

17.0	0.4	17.8	16.9	15.2	53364-40 19	40
15.4	0.4	16.2	15.3	13.6	53364-36 19	36
13.0	0.8	13.8	12.9	11.2	53364-30 19	30
12.2	0.4	13.0	12.1	10.4	53364-28 19	28
9.0	0.4	9.8	8.9	7.2	53364-20 19	20
8.2	0.8	9.0	8.1	6.4	53364-18 19	18
5.8	0.4	6.6	5.7	4.0	53364-12 19	12
5.0	0.8	5.8	4.9	3.2	53364-10 19	10
E	D	C	B	A	MATERIAL NO.	極致 CKT

REVISED EC NO: J2008-3931 DRAWN: NAKAMURA 2008/05/26 CHKD: T. HARUYAMA 2008/05/26 APPR: NUKITA 2008/08/21	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
		10 UNDER	± 0.2	DRAWN BY M. NABEI		TITLE 0.8 BOARD TO BOARD CONN. WAFER ASS ST.SMT -LEAD FREE-			
		10 OVER 30 UNDER	± 0.25	CHECKED BY K. TOJO					
		30 OVER	± 0.3	APPROVED BY M. SASAO		MOLEX INCORPORATED			
		ANGULAR ± 3 °		MATERIAL NO.		DOCUMENT NO.		SHEET NO.	
REV	A	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE TABLE		SD-53364-001		1 OF 1	
				THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					

